## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3907757

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HIROYUKI YASUKOCHI	03/11/2016

### **RECEIVING PARTY DATA**

Name:	SONY CORPORATION
Street Address:	1-7-1 KONAN
Internal Address:	MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	1080075

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15102607

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	SP354016US00	
NAME OF SUBMITTER:	PRAMOD CHINTALAPOODI	
SIGNATURE:	/Pramod Chintalapoodi/	
DATE SIGNED:	06/08/2016	

**Total Attachments: 1** 

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**PATENT** REEL: 038841 FRAME: 0318 503861108

Attorney Docket No.: Sony Ref. No.: SP354016US00

# DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	MODELING APPARATUS AND MODELING METHOD	
As the below	named inventor, I hereby declare that:	
This declarati	on The attached application, or	
	United States application or PCT international application number FCT/JP2014/006230 filed on 2014/12/15	
The above-id	entified application was made or authorized to be made by me.	
WHEREAS,  1-7-1 KC acquiring all	I am the original inventor or an original joint inventor of a claimed invention in the application.  SONY CORPORATION  NAN, MINATO-KU, TOKYO, 108-0075, JAPAN  (hereinafter referred to as ASSIGNEE), is desirous of interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar on which may be granted therefor in the United States and in any and all foreign countries;	
NOW THER of which are legal represer in and to any any and all pr Convention F adheres, and United States	EFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and statives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to irority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American telating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters ASSIGNEE, as the assignee of the whole right, title and interest thereto;	
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;		
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;		
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;		
And I hereby this assignme	covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with nt and sale.	
	nowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of a five (5) years, or both.	
LEGAL NAM	ME OF INVENTOR	
Inventor:	HIROYUKI YASUKOCHI  Date: march 11, 2016	
Signature: _	Hroyski Jesukochi	

PATENT REEL: 038841 FRAME: 0319

**RECORDED: 06/08/2016**